



Material Content Data Sheet



Sales Product Name		ICE3AR2280CJZ		Issued		19. July 2018		
MA#		MA001205946						
Package		PG-DIP-7-4		Weight*		652.91 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.632	0.71	0.71	7094	7094
leadframe	inorganic material	phosphorus	7723-14-0	0.049	0.01		74	
	non noble metal	zinc	7440-66-6	0.194	0.03		297	
	non noble metal	iron	7439-89-6	3.884	0.60		5950	
wire	non noble metal	copper	7440-50-8	157.726	24.16	24.80	241575	247896
	noble metal	gold	7440-57-5	0.267	0.04	0.04	409	409
encapsulation	organic material	carbon black	1333-86-4	1.427	0.22		2186	
	plastics	epoxy resin	-	46.142	7.07		70672	
	inorganic material	silicondioxide	60676-86-0	428.125	65.56	72.85	655723	728581
leadfinish	non noble metal	tin	7440-31-5	6.460	0.99	0.99	9894	9894
plating	noble metal	silver	7440-22-4	1.911	0.29	0.29	2927	2927
glue	plastics	epoxy resin	-	0.313	0.05		480	
	noble metal	silver	7440-22-4	1.775	0.27	0.32	2719	3199
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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